

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM FILING DATE CLASS SUBCLASS GAU EXAMINER
10073173 02/13/2002 438 5.2 2812 L F AM

**APPLICANTS: Kim Gu-Sung;

**CONTINUING DATA VERIFIED:

** FOREIGN APPLICATIONS VERIFIED:

PG-PUB DO NOT PUBLISH ☐

RESCIND ☐

Foreign priority claimed ☐ yes ☐ no
35 USC 119 conditions met ☐ yes ☐ no

Verified and Acknowledged Examiners's initials

ATTORNEY DOCKET NO

259/014

TITLE : Wafer level package with air pads and manufacturing method thereof

U.S. DEPT. OF COMM. (PAT. & TM. PROC. 336) (REV. 12-01)

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
			Total Claims	Print Claim for O.G.
ISSUE FEE		Primary Examiner	DRAWING	
Amount Due	Date Paid		Sheets Drwg.	Figs. Drwg.
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Application Examiner	
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